



Material Content Data Sheet



Sales Product Name		BFR 460L3 E6327		Issued		25. January 2018		
MA#		MA001608864						
Package		PG-TSLP-3-1		Weight*		0.54 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.000	0.09		855	
	noble metal	gold	7440-57-5	0.002	0.33		3315	
	inorganic material	silicon	7440-21-3	0.016	2.86	3.28	28614	32784
leadframe	non noble metal	nickel	7440-02-0	0.071	13.10	13.10	130996	130996
wire	noble metal	gold	7440-57-5	0.012	2.12	2.12	21213	21213
encapsulation	inorganic material	antimonytrioxide	1309-64-4	0.000	0.04		393	
	organic material	carbon black	1333-86-4	0.004	0.79		7866	
	plastics	epoxy resin	-	0.058	10.62		106197	
	inorganic material	silicondioxide	60676-86-0	0.366	67.21	78.66	672191	786647
leadfinish	noble metal	gold	7440-57-5	0.008	1.42	1.42	14180	14180
plating	noble metal	gold	7440-57-5	0.008	1.42	1.42	14180	14180
*deviation	< 10%			Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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